



## Boeing Diversity Scholarship Application

### A. New and Continuing Student Requirements

- Complete the Free Application for Federal Student Aid ([www.fafsa.ed.gov](http://www.fafsa.ed.gov)).
- Submit a complete application packet.
- Demonstrate a cumulative GPA of 3.2 or above in the last 90 quarter or 60 semester credits.
- Must be enrolled in a minimum of 12 credits per quarter at UWT.
- You must be admitted into one of the Institute programs and have all official transcripts on file.

### B. All Students

#### **Applicants must provide the following in one complete packet:**

- Application form (see next page)
- Professional or Academic Recommendation
- All official transcripts must be on file
- List of service or leadership activities for your college campus and/or local community
- **Personal Essay: The essay should provide what activities/experiences you have had with diversity and what it meant to you, how your diversity activities enhance your study of technology, your current research, areas of interest, and extra-curricular activities, your future career goals. \*\*\*All items must be included in order to be considered for the scholarship.\*\*\***

# Boeing Diversity Scholarship Application

## C. Applicant Information

Name \_\_\_\_\_ Student ID \_\_\_\_\_  
Address \_\_\_\_\_ Zip Code \_\_\_\_\_ Phone \_\_\_\_\_  
Email \_\_\_\_\_ Undergraduate Program:  ITS  CSCI  CES  EE  
 New Student  Continuing Student  
Expected Enrollment  Full time  Part time  
Expected Graduation Quarter: \_\_\_\_\_ Year: \_\_\_\_\_  
Apply Scholarship to:  Aut  Win  Spr  
Will you be receiving tuition funding from your employer?  No  
 Yes If yes, how much: \_\_\_\_\_

## D. Professional/Faculty Recommendation

List information for the individual providing your recommendation. Submit the recommendation with all other required documentation.

Recommender \_\_\_\_\_  
Title or Position \_\_\_\_\_  
Relationship \_\_\_\_\_  
Email \_\_\_\_\_ Phone \_\_\_\_\_

## E. Attachments

All documentation must be submitted and attached to this application in one complete packet, see section B for complete list.

## F. Signature

I understand that any portion of this application may be released to the public should I be offered and accept this award. Information provided will become the property of the School of Engineering & Technology and the University of Washington and will not be returned. Ranking of applicants will not be disclosed. Please print, sign and include with your application packet.

Applicant Signature \_\_\_\_\_ Date \_\_\_\_\_

**Incomplete application packets items will not be considered.**

University of Washington, Tacoma  
School of Engineering & Technology  
Attn: Scholarship Committee  
Campus Box 358426  
1900 Commerce St.  
Tacoma, WA 98402